Notification about the transfer of the semiconductor business

The semiconductor business of Panasonic Corporation was transferred on September 1, 2020 to Nuvoton Technology Corporation (hereinafter referred to as "Nuvoton"). Accordingly, Panasonic Semiconductor Solutions Co., Ltd. became under the umbrella of the Nuvoton Group, with the new name of Nuvoton Technology Corporation Japan (hereinafter referred to as "NTCJ").

In accordance with this transfer, semiconductor products will be handled as NTCJ-made products after September 1, 2020. However, such products will be continuously sold through Panasonic Corporation.

Publisher of this Document is NTCJ.

If you would find description "Panasonic" or "Panasonic semiconductor solutions", please replace it with NTCJ.

Except below description page
 "Request for your special attention and precautions in using the technical information and semiconductors described in this book"

Nuvoton Technology Corporation Japan

Doc No. TT4-EA-12592

Revision. 2

MOS FET

FK3306010L

Panasonic

FK3306010L

Silicon N-channel MOSFET

For switching FK350601 in SSSMini3 type package

Features

Low drive voltage: 2.5 V drive
Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: CV

Established: 2010-05-20

Revised

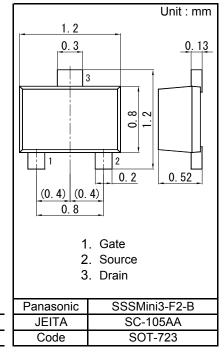
: 2013-08-08

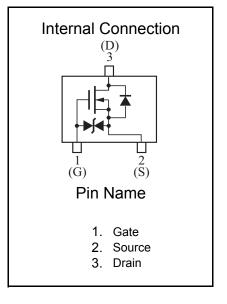
■ Packaging

Embossed type (Thermo-compression sealing):10 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

| Parameter | Symbol | Rating | Unit |
|-------------------------------|--------|-------------|------|
| Drain-source voltage | VDS | 60 | V |
| Gate-source voltage | VGS | ±12 | V |
| Drain current | ID | 100 | mA |
| Pulse drain current | IDp | 200 | mA |
| Total power dissipation | PD | 100 | mW |
| Channel temperature | Tch | 150 | °C |
| Operating Ambient Temperature | Tstg | -40 to +85 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |





MOS FET

FK3306010L

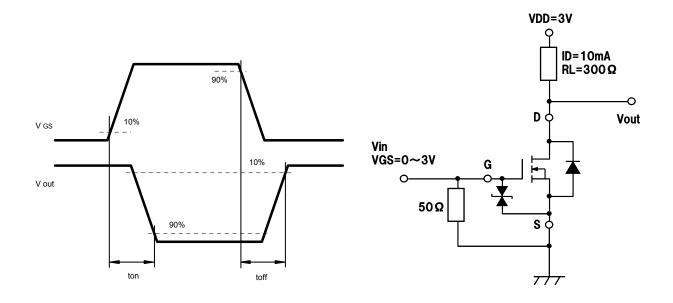
Panasonic

■ Electrical Characteristics Ta = 25 °C ± 3 °C

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--------------------------------|----------|----------------------------------|-----|-----|-----|------|
| Drain-source breakdown voltage | VDSS | ID = 1 mA, VGS = 0 | 60 | | | V |
| Drain-source cutoff current | IDSS | VDS = 60 V, VGS = 0 | | | 1.0 | μΑ |
| Gate-source cutoff current | IGSS | VGS = ±10 V, VDS = 0 | | | ±10 | μΑ |
| Gate threshold voltage | VTH | ID = 1.0 μA, VDS = 3.0 V | 0.9 | 1.2 | 1.5 | V |
| Drain-source ON resistance | RDS(on)1 | ID = 10 mA, VGS = 2.5 V | | 8 | 15 | Ω |
| | RDS(on)2 | ID = 10 mA, VGS = 4.0 V | | 6 | 12 | Ω |
| Forward transfer admittance | Yfs | ID = 10 mA, VDS = 3 V, f = 1 kHz | 20 | 60 | | mS |
| Input capacitance | Ciss | | | 12 | | pF |
| Output capacitance | Coss | VDS = 3 V, VGS = 0, f = 1 MHz | | 7 | | pF |
| Reverse transfer capacitance | Crss | | | 3 | | pF |
| Turn-on time *1 | ton | VDD = 3 V, VGS = 0 to 3 V, | | 100 | | |
| | | RL = 300 Ω | | | | ns |
| Turn-off time *1 | toff | VDD = 3 V, VGS = 3 to 0 V, | | 100 | | 200 |
| | | RL = 300Ω | ' | 100 | , | ns |

1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

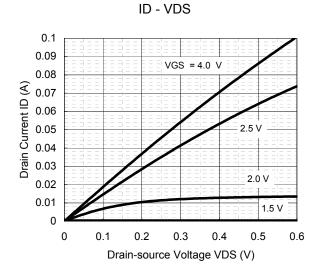
2. *1 Turn-on and Turn-off test circuit

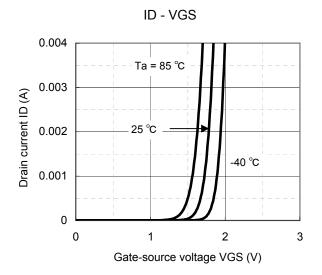


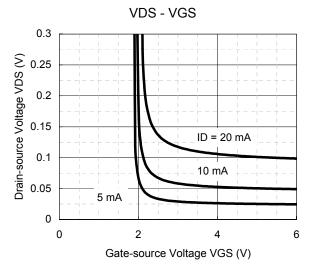
Established: 2010-05-20 Revised

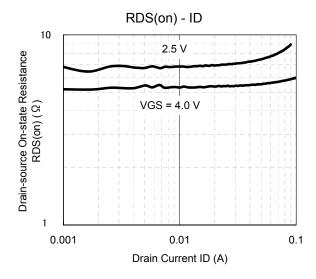
MOS FET FK3306010L



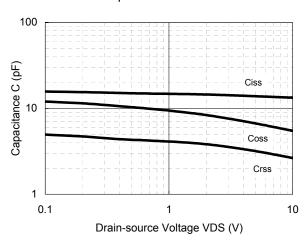








Capiacitance - VDS

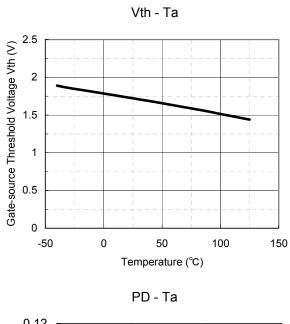


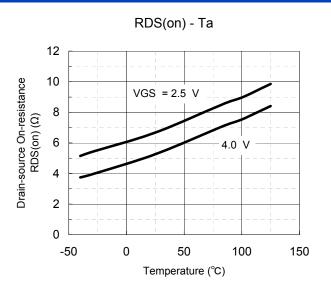
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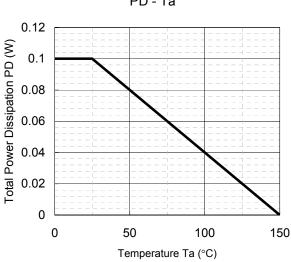
Established: 2010-05-20 Revised

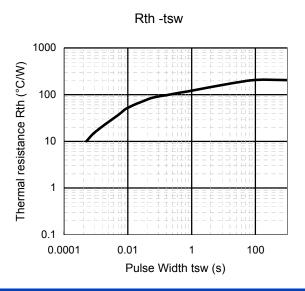
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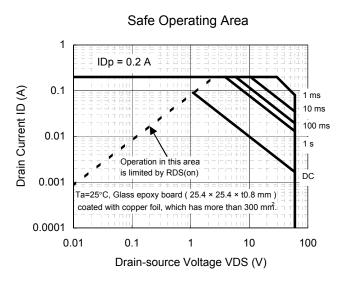
MOS FET **FK3306010L**











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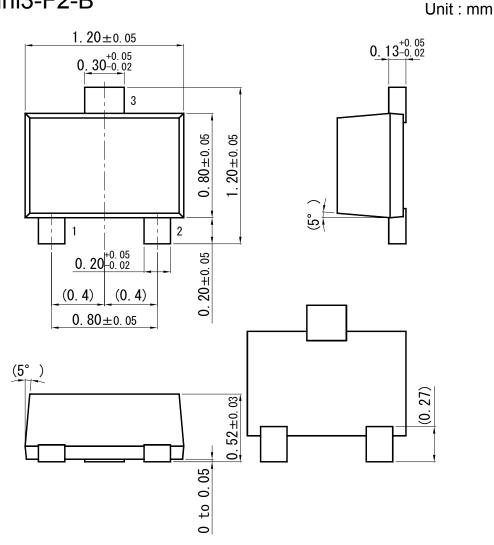
Established: 2010-05-20 Revised: 2013-08-08

Panasonic

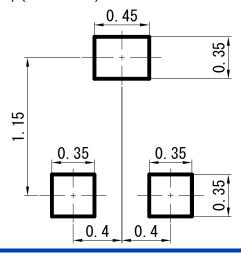
MOS FET

FK3306010L

SSSMini3-F2-B



■ Land Pattern (Reference) (Unit: mm)



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Established: 2010-05-20 Revised: 2013-08-08

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